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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:

Confirmation No.: 5977

M. NAGASHIMA

Group Art Unit: 2835

Serial No.: 09/646,906

Examiner: A. Vortman

Filed: October 10, 2000

Docket No. 100806-00001

For: MOUNTING STRUCTURE FOR TEMPERATURE-SENSITIVE FUSE ON  
CIRCUIT BOARD

AMENDMENT UNDER 37 C.F.R. § 1.111

Commissioner for Patents  
Washington, D.C. 20231

Date: November 27, 2002

Sir:

This paper is filed in response to the Office Action dated August 29, 2002. In the prosecution of the application identified above, please consider the following remarks.

IN THE CLAIMS:

Please cancel claim 3.

Please amend claim 1 as follows:

1. (Amended) A mount structure for thermal fuse on circuit board, comprising:
- a circuit board having one surface where a predetermined circuit is formed;
  - a through opening provided in said circuit board;
  - an electronic component attached to the one surface of said circuit board to extend across said through opening;

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